



Targets for nuclear physics studies



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Nuclear reaction is a process in which two, three nuclei or nuclei and particle such as neutron, proton ... collide producing the product other than the initial 'items'.





The first artificial nuclear reaction was performed by John Cockcroft and Ernest Walton in 1932. They bombarded the ⁷Li with 'artificially' accelerated protons. In result the two helium nuclei (α particles) were created.

What is the target?

Gasous or liquid

- gas or liquid flow (the melted metals as well)
- material closed in the chamber kept in the low temperature
- in case of gaseous target: implantation into the solid backing/carrier



What is the target?

Rutherford transmutation "An anomalous effect in nitrogen,"

the alpha particle (from Polonium) which passed through the container with nitrogen gas and nitrogen nucleus stuck together, with a proton flying loose.

$$^{14}N + \alpha \rightarrow ^{17}O + p$$



The aparatus used by Rutherford in 1919 for transmutation of nitrogen into oxygen

What is the target?

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- gas or liquid flow (the melted metals as well)
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Solid targets

- self supporting
- on the backing





How to make the target?

The choice of the method depends on many aspects:

- •target form (phase) and characteristics/parameters: element/isotope, thickness, size
- •availability of the tools/method in the target lab
- •avoiding unnecessary costs
- •avoiding contamination of the material

Target properties/characteristic

Target material: element-isotope and its phase: solid, liquid, gaseousThickness and its homogeneityChemical form required and availableSelf-supporting or on the backing

mechanical shaping:

rolling

tablet pressing







chemically: electro-deposition from hydrous or organic medium (always on the backing)



How ???

vapour deposition in the high vacuum (self-supporting or on the backing) -resistance heating -e-gun -sputtering

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sputtering i.e. target material ejection by accelerated ions of the nobel gas





carbon arc laser ablation e-gun





Resistance heating

 The method is very simple, robust

but

- limited to the materials of the low melting point (not higher then 1800 °C)
- and not alloying with the boat material.

E-gun

- The method is more complex, but extremely versatile.
- Can achieve temperatures in excess of 3000°C.
- Use evaporation cones or crucibles in a water cooled copper hearth.
- Typical emission voltage is 8-10 kV.

but

- Exposes substrates to secondary electron radiation.
- X-rays can also be generated by high voltage electron beam

Sputtering

- The method can be applied to the most of the materials except those which can degrade due to ionic bombardment
- This technology allows to released the deposited material at much lower temperature than evaporation.
- gives easy film thickness control via time, allows alloy deposition, no x-ray damage

but

- requires rather big surface of the sputtered material to avoid bombarding of the cathode material.
- There is as well big chance for the impurities incorporation due to low vacuum.



on the backing or self-supporting

backings

thin metal foils

carbon foil

plastic: Mylar, Kapton, Formvar







How???



by vapour deposition on substrate







Thickness:

(mass/area i.e. g-mg-µg/cm²)



1 b (σ)= 10⁻²⁴ cm²

it's approx. the sectional area of the U nucleus

Thickness estimation: mass/area i.e. g-mg-µg/cm²)

- * mechanically or electrically i.e. using caliper, micrometer screw??) or thickness induction gauge
- * weighing the defined area
- * in-situ during the vapour deposition process using the quartz microbalance
- * spectrophotometrically
- * measurement of the α particles or X-ray energy
- * profilometers
 - working in a contact or non-contact modes





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Thickness estimation of the radioactive targets;

if made by evaporation: during preparation with quartz microbalance *ready target:* measurements of the radioactivity

thickness homogeneity by radioactivity scan across the target area





Workshop, July 2012

Target characterisation

Target characterisation

Thickness: (mass/area i.e. g-mg-µg/cm²)

Thickness homogeneity:

?

Surface characterisation



Surface characterisation



AFM images of tristearin layer



Target characterisation

Thickness: (mass/area i.e. g-mg-µg/cm²)

Thickness homogeneity (including surface topography)

Purity/composition

Purity/composition



Workshop, July 2012

Target characterisation



When ordering a target define the characteristic needed/significant for planned studies but avoid exaggeration i.e. do not order a target with much better characteristic than really needed. This may cause additional costs and/or ... delay.

element/isotope thickness, dimensions supported or not, if yes what can be considered as support purity

Do not overestimate the importance of the chemical form of the target material.

not always have to be a pure elemental form, the compounds may suite your needs as well but often it is much easier (cheaper) to make the target from compound

Discuss with target maker your planned target. Target preparation people can do sometimes more for you than you believe; it is often a question of communication and of raising the relevant problems/aspects.



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